

MSARW80G20A (MX028)

Features

- Oxide passivated structure for very low leakage currents
- Epitaxial structure minimizes forward voltage drop
- Hermetically sealed, low profile ceramic surface mount power package
- Low package inductance
- Very low thermal resistance
- available with TXV (MSARW80G20AV) or S-level (MSARW80G20AS) screening i.a.w. Microsemi internal procedure PS11.50

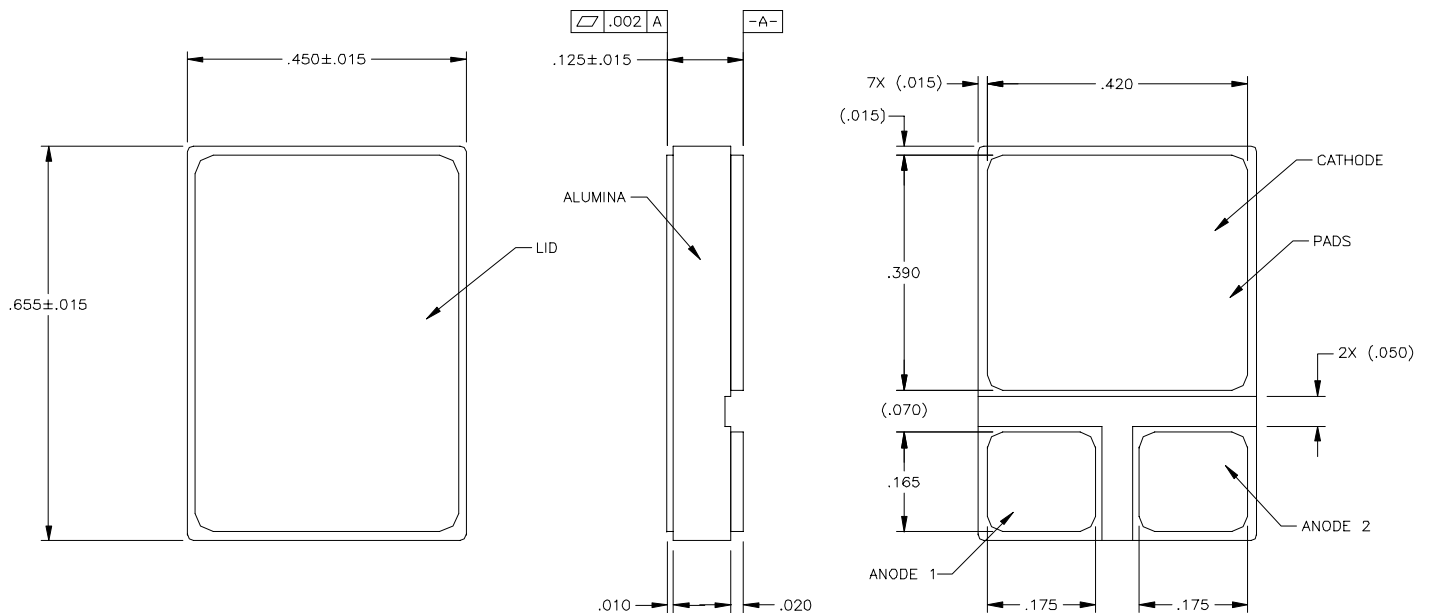
**200 Volts
 80 Amps
 37 ns**

**ULTRAFAST
 RECTIFIER**

Maximum Ratings @ 25°C (unless otherwise specified)

| DESCRIPTION | SYMBOL | MAX. | UNIT |
|-----------------------------------------------------------------|---------------|-------------------|--------------------|
| Peak Repetitive Reverse Voltage | V_{RRM} | 200 | Volts |
| Working Peak Reverse Voltage | V_{RWM} | 200 | Volts |
| DC Blocking Voltage | V_R | 200 | Volts |
| Average Rectified Forward Current, $T_c \leq 135^\circ\text{C}$ | $I_{F(ave)}$ | 80 | Amps |
| Nonrepetitive Peak Surge Current, $t_p = 8.3$ ms, half-sinewave | I_{FSM} | 250 | Amps |
| Junction Temperature Range | T_j | -65 to +200 | $^\circ\text{C}$ |
| Storage Temperature Range | T_{stg} | -65 to +200 | $^\circ\text{C}$ |
| Thermal Resistance, Junction to Case | θ_{JC} | 0.8 (typ.0.35) | $^\circ\text{C/W}$ |

Mechanical Outline



MSARW80G20A (MX028)



Electrical Parameters

| DESCRIPTION | SYMBOL | CONDITIONS | MIN | TYP. | MAX | UNIT |
|-----------------------------------------------------------------------------|---------------|--------------------------------------------------------------------------------|-----|------|------|---------------|
| Reverse (Leakage) Current | I_{R25} | $V_R = 200 \text{ Vdc}, T_c = 25^\circ\text{C}$ | | - | 250 | μA |
| | I_{R100} | $V_R = 200 \text{ Vdc}, T_c = 100^\circ\text{C}$ | | - | 10 | mA |
| Forward Voltage pulse test, $p_w = 300 \mu\text{s}$ $d/c \leq 2\%$ | VF1 | $I_F = 5 \text{ A}, T_c = 25^\circ\text{C}$ | | 720 | 750 | mV |
| | VF2 | $I_F = 25 \text{ A}, T_c = 25^\circ\text{C}$ | | 860 | 900 | mV |
| | VF3 | $I_F = 50 \text{ A}, T_c = 25^\circ\text{C}$ | | 950 | 1050 | mV |
| | VF4 | $I_F = 80 \text{ A}, T_c = 25^\circ\text{C}$ | | 1050 | | mV |
| | VF5 | $I_F = 50 \text{ A}, T_c = -55^\circ\text{C}$ | | | 1150 | mV |
| | VF6 | $I_F = 50 \text{ A}, T_c = 100^\circ\text{C}$ | | 830 | | mV |
| Junction Capacitance | C_{j1} | $V_R = 10 \text{ Vdc}$ | | | 500 | pF |
| Reverse Recovery Time | t_{rr} | $I_F = 9.9 \text{ A}, dI_F/dt = 200 \text{ A}/\mu\text{s}, V_r = 30 \text{ V}$ | | 35 | 37 | ns |
| Reverse Recovery Current | $I_{RM(rec)}$ | $I_F = 9.9 \text{ A}, dI_F/dt = 200 \text{ A}/\mu\text{s}, V_r = 30 \text{ V}$ | | 5 | 5.5 | A |
| Breakdown Voltage | BVR | $I_R = 250 \mu\text{A}, T_c = 25^\circ\text{C}$ | 200 | | | V |

